RELIABILITY TEST REPORT

TESTITEM: 1.ELECTRICAL

2.MECHANICAL

3.ENVIRONMENTAL

SERIES NO.: CI15 For Using Lead-free

TEST EQUIPMENT: 1.INSERTION & REMOVAL APPARATUS

2.ELECTRONIC MEASURING APPARATUS

3.ENVIRONMENTAL APPARATUS

DATE OF TESTING: 3 / 15 / 05

TEST DEPART: QA TESTER: Scott.Lien

CONTAINT: ATTACHED

REVIEWED: Jackal APPROVED: Rita VERIFIED: Scott.Lien.

1.ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT	TES	ST RESULT
1-1	Contact resistance	Dry circuit of DC 20 mV	Less than $20 \text{ m}\Omega$	Sample	$20 \text{ m}\Omega$ max.
		max.100 mA max.		1	$1.85~\mathrm{m}\Omega$
				2	$1.83~\mathrm{m}\Omega$
				3	$1.89~\mathrm{m}\Omega$
				4	$1.86~\mathrm{m}\Omega$
				5	$1.81~\mathrm{m}\Omega$
1-2	Dielectric strength	When applied AC 500 V 1	No change	Sample	500 V 1 minute
		minute between adjacent		1	Pass
				2	Pass
		terminar		3	Pass
				4	Pass
				5	Pass
1-3	Insulation resistance	When applied DC 500 V	More than 500 M Ω	Sample	$500 \mathrm{M}\Omega$ min.
		between adjacent terminal or ground		1	$25\times10^5 \mathrm{M}\Omega$
				2	$35\times10^5 \mathrm{M}\Omega$
		or ground		3	$30\times10^5 \mathrm{M}\Omega$
				4	$40\times10^5 \mathrm{M}\Omega$
				5	$30\times10^5 \mathrm{M}\Omega$

2. MECHANICAL PERFORMANCE:

2	-1	Pin retention force	Push pin from insulator	More than 0.7 Kgf	Sample	> 0.7 Kgf
			base at speed 25±3 mm per		1	1.29 Kgf
			minute		2	1.34 Kgf
					3	1.17 Kgf
					4	1.45 Kgf
					5	1.26 Kgf

3. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT	TEST RESULT	
3-1	1	Then carried the rated current	30 max.	Sample	30 max.
3-2		TT7/ ' 1 0 1 C	Appearance: No damage	Sample	No damage
			Discontinuity: 1 micro second max.	Sample	1 micro second max.

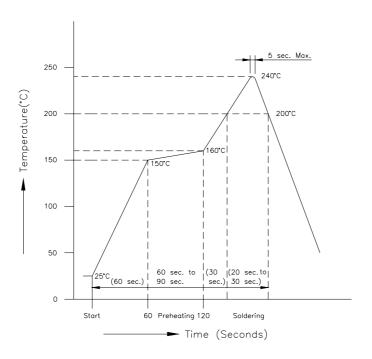
3-3	Solderability	Soldering time: 5 ± 0.5 sec.	Minimum:	Sample	90% of Immersed ar
		Soldering pot:230 ± 5	90% of immersed	1	Pass
		Boldering pot.230 ± 3	area	2	Pass
				3	Pass
				4	Pass
				5	Pass
3-4	Resistance to soldering heat	Soldering time: 5 ± 0.5 sec. Soldering pot:260 ± 5	No damage	Sample	No damage
				1	Pass
				2	Pass
				3	Pass
				4	Pass
				5	Pass
3-5	Heat aging	85 ± 2 , 96 hours	No damage	Sample	No damage
				1	Pass
				2	Pass
				3	Pass
				4	Pass
				5	Pass
3-6	Humidity	40 ± 2 , 90-95% RH, 96 hours measurement must be taken within 30 min. after tested	Appearance:	Sample	No damage
			No damage	1	Pass
				2	Pass
				3	Pass
				4	Pass
				5	Pass
			Contact resistance:	Sample	
			Less than twice of	1	1.88 mΩ
			initial	2	$1.89~\mathrm{m}\Omega$
				3	$1.86~\mathrm{m}\Omega$
				4	$1.91~\mathrm{m}\Omega$
				5	$1.85~\mathrm{m}\Omega$
			Dielectric strength: To pass Para 1-2	Sample	Pass para 1-2
				1	Pass
				2	Pass
				3	Pass
				4	Pass
				5	Pass
3-7	Temperature cycling	One cycle consists of:	Appearance: No damage	Sample	No damage
		155 ⁻³ , 30 min 2. Room temp. 10-15 min		1	Pass
				2	Pass
				3	Pass
		3. $85^{\frac{1}{4}}$, 30 min		4	Pass
		4. Room temp. 10-15 min		5	Pass

			Contact resistance:	Sample	< twice of initial
			Less than twice of	1	$1.93~\mathrm{m}\Omega$
			initial	2	$1.94~\mathrm{m}\Omega$
				3	$1.87~\mathrm{m}\Omega$
				4	$1.89~\mathrm{m}\Omega$
				5	$1.90~\mathrm{m}\Omega$
3-8	Salt spray	Temperature: $35 \pm 3^{\circ}$ C	Appearance:	Sample	No damage
	Solution	Solution:5 ± 1%	No damage	1	Pass
				2	Pass
		Spray time: 48 ± 4 hours		3	Pass
	Measurement must be taken	1	4	Pass	
		after water rinse		5	Pass
			Contact resistance:	Sample	< twice of initial
			Less than twice of	1	$1.91~\mathrm{m}\Omega$
			initial	2	$1.97~\mathrm{m}\Omega$
				3	$1.95~\mathrm{m}\Omega$
				4	1.94 mΩ
				5	$1.97~\mathrm{m}\Omega$

4. AMBIENT TEMPERATURE RANGE:-25 to +85

• Recommended Temperature Profile

• Using Typical Solder Paste



Using Lead-free Solder Paste

